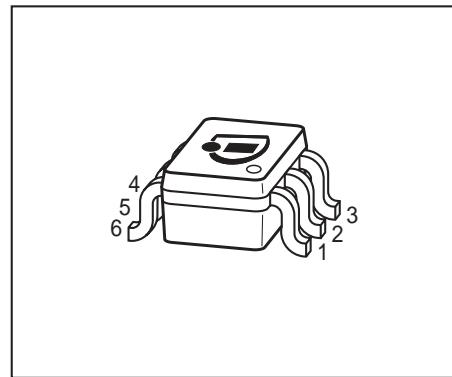


## NPN Silicon RF Transistor

- For broadband amplifiers up to 1 GHz at collector currents from 1 mA to 20 mA
- BFS17S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



**ESD (Electrostatic discharge) sensitive device, observe handling precaution!**

Type	Marking	Pin Configuration						Package
BFS17S	MCs	1=B1	2=E1	3=C2	4=B2	5=E2	6=C1	SOT363

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	15	V
Collector-base voltage	$V_{CBO}$	25	
Emitter-base voltage	$V_{EBO}$	2.5	
Collector current	$I_C$	25	mA
Peak collector current, $f = 10$ MHz	$I_{CM}$	50	
Total power dissipation <sup>2)</sup>	$P_{tot}$	280	mW
$T_S \leq 93$ °C			
Junction temperature	$T_j$	150	°C
Ambient temperature	$T_A$	-65 ... 150	
Storage temperature	$T_{stg}$	-65 ... 150	

### Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>3)</sup>	$R_{thJS}$	$\leq 240$	K/W

<sup>1</sup>Pb-containing package may be available upon special request

<sup>2</sup> $T_S$  is measured on the collector lead at the soldering point to the pcb

<sup>3</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

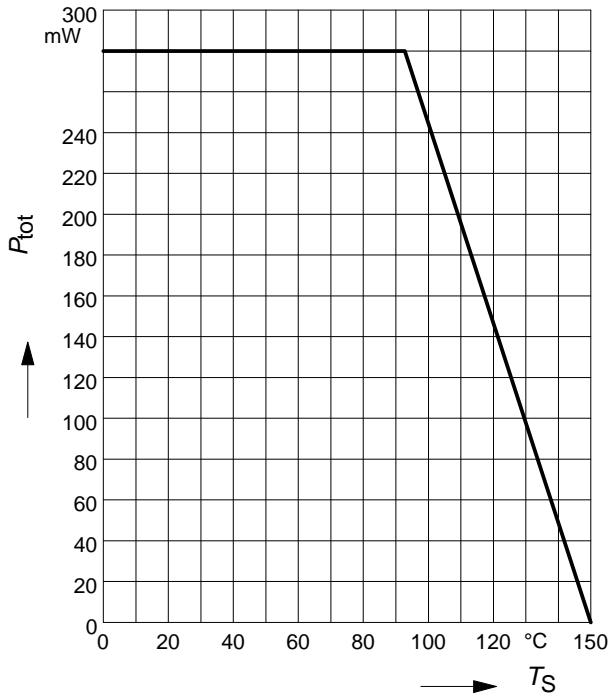
#### DC Characteristics

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	15	-	-	V
Collector-base cutoff current $V_{CB} = 10 \text{ V}, I_E = 0$ $V_{CB} = 25 \text{ V}, I_E = 0$	$I_{\text{CBO}}$	-	-	0.05 10	$\mu\text{A}$
Emitter-base cutoff current $V_{EB} = 2.5 \text{ V}, I_C = 0$	$I_{\text{EBO}}$	-	-	100	
DC current gain- $I_C = 2 \text{ mA}, V_{CE} = 1 \text{ V}$ , pulse measured $I_C = 25 \text{ mA}, V_{CE} = 1 \text{ V}$ , pulse measured	$h_{\text{FE}}$	40 20	- 70	150 -	-
Collector-emitter saturation voltage $I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$	$V_{\text{CEsat}}$	-	0.1	0.4	V

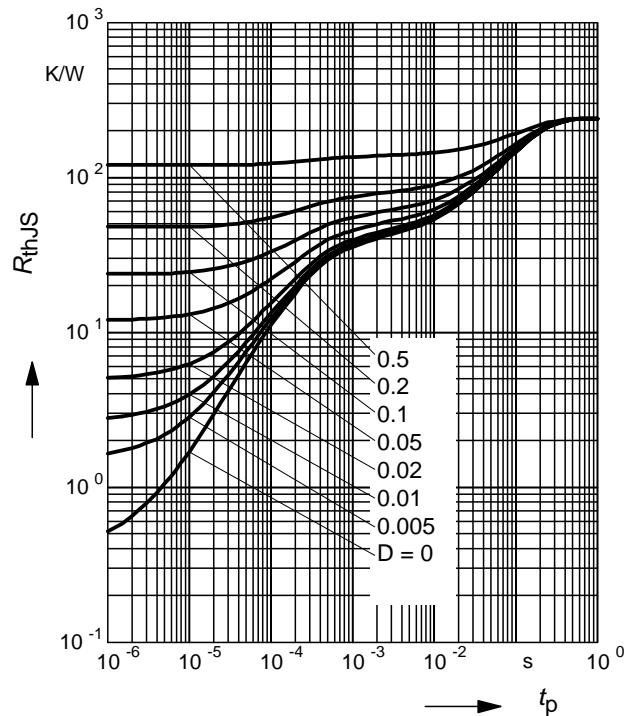
**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b> (verified by random sampling)					
Transition frequency $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 200 \text{ MHz}$ $I_C = 25 \text{ mA}, V_{CE} = 5 \text{ V}, f = 200 \text{ MHz}$	$f_T$	1 1.3	1.4 2.5	- -	GHz
Collector-base capacitance $V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ , emitter grounded	$C_{cb}$	-	0.55	0.8	pF
Collector emitter capacitance $V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ , base grounded	$C_{ce}$	-	0.2	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0$ , collector grounded	$C_{eb}$	-	0.9	1.45	
Noise figure $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, Z_S = 50 \Omega$ , $f = 800 \text{ MHz}$	$F$	-	3	5	dB
Transducer gain $I_C = 20 \text{ mA}, V_{CE} = 5 \text{ V}, Z_S = Z_L = 50\Omega$ , $f = 500 \text{ MHz}$	$ S_{21e} ^2$	-	14	-	dB
Third order intercept point at output $V_{CE} = 5 \text{ V}, I_C = 20 \text{ mA}, f = 800 \text{ MHz}$ , $Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}$	$IP_3$	-	22.5	-	dBm
1dB Compression point $I_C = 20 \text{ mA}, V_{CE} = 5 \text{ V}, Z_S = Z_L = 50\Omega$ , $f = 800 \text{ MHz}$	$P_{-1\text{dB}}$	-	11	-	-

**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

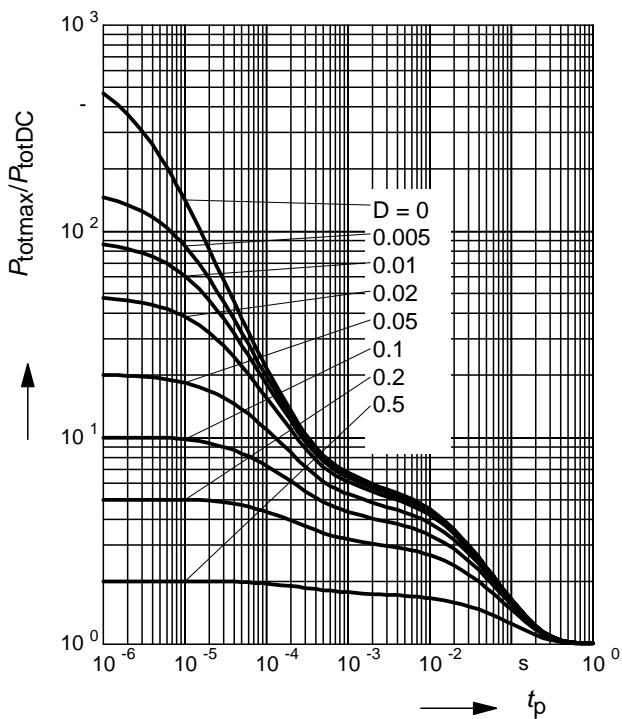


**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$



**Permissible Pulse Load**

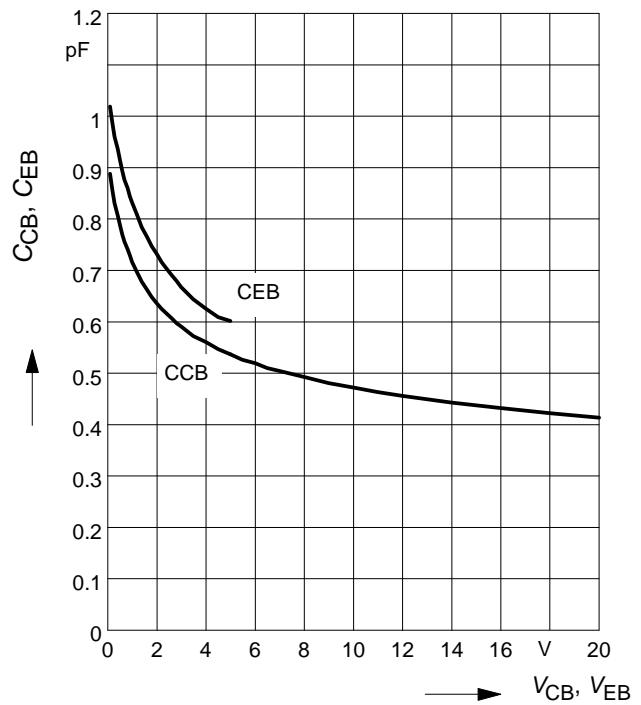
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$



**Collector-base capacitance**  $C_{\text{cb}} = f(V_{\text{CB}})$

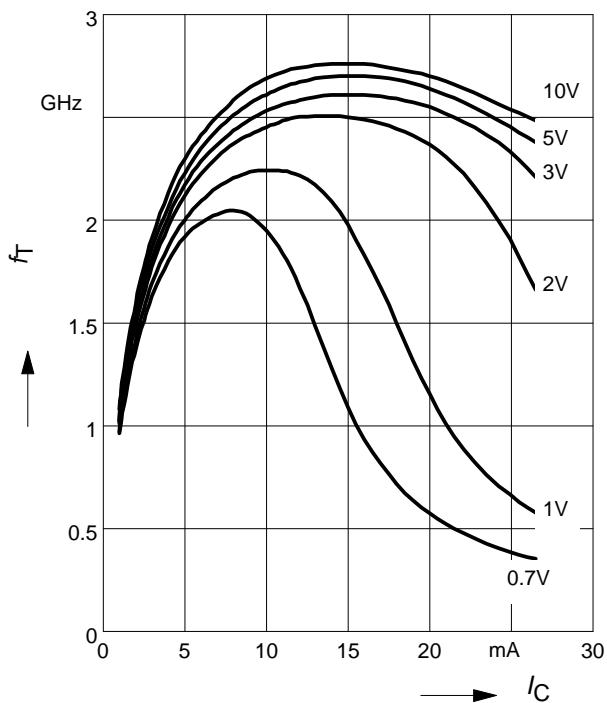
**Emitter-base capacitance**  $C_{\text{eb}} = f(V_{\text{EB}})$

$$f = 1 \text{ MHz}$$

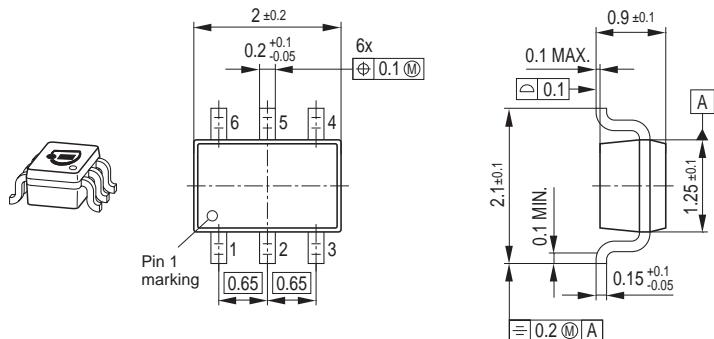


**Transition frequency  $f_T = f(I_C)$**

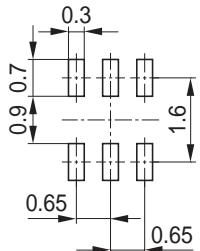
$V_{CE}$  = parameter



### Package Outline

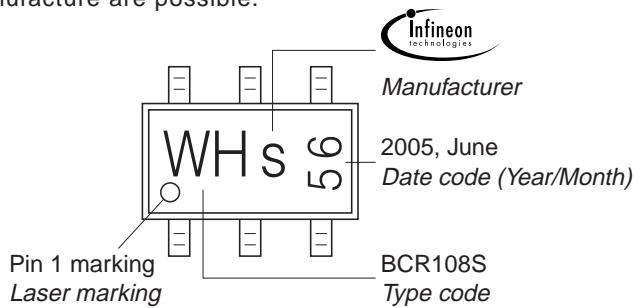


### Foot Print



### Marking Layout (Example)

Small variations in positioning of Date code, Type code and Manufacture are possible.

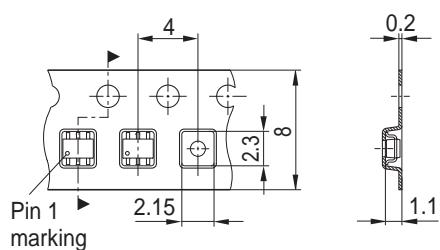


### Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel

Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



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